

# WP934CA/2YD-90

T-1 (3mm) Bi-Level Circuit Board Indicator

# DESCRIPTION

 The Yellow source color devices are made with Gallium Arsenide Phosphide on Gallium Phosphide Yellow Light Emitting Diode

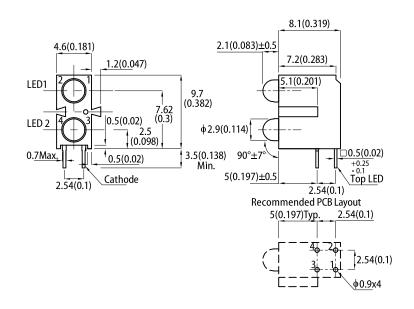
# **FEATURES**

- · Pre-trimmed leads for pc mounting
- Black case enhances contrast ratio
- Wide viewing angle
- High reliability life measured in years
- Housing UL rating: 94V-0
- Housing material: Type 66 nylon
- RoHS compliant

# **APPLICATIONS**

- Status indicator
- Illuminator
- Signage applications
- · Decorative and entertainment lighting
- · Commercial and residential architectural lighting

# PACKAGE DIMENSIONS



Notes.

- 1. All dimensions are in millimeters (inches)
- Tolerance is ±0.25(0.01") unless otherwise noted.
   Lead spacing is measured where the leads emerge from the package.
- The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.

# **SELECTION GUIDE**

Part Number	Emitting Color	Lens Type	lv (mcd) @ 10mA <sup>[2]</sup>		Viewing Angle <sup>[1]</sup>	
Fait Number	(Material)	Lens Type	Min.	Тур.	201/2	
WP934CA/2YD-90	Yellow (GaAsP/GaP)	Yellow Diffused	8	15	50°	

Notes

- 41/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
   2. Luminous intensity / luminous flux: +/-15%.
   3. Luminous intensity value is traceable to CIE127-2007 standards.

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### ELECTRICAL / OPTICAL CHARACTERISTICS at T<sub>A</sub>=25°C

Deventer	0h.al	Ensitting Oslan	Value		Unit
Parameter	Symbol	Emitting Color	Тур.	Typ. Max.	
Wavelength at Peak Emission $I_F = 10 \text{mA}$	$\lambda_{peak}$	Yellow	590	-	nm
Dominant Wavelength I <sub>F</sub> = 10mA	$\lambda_{dom}$ <sup>[1]</sup>	Yellow	588	-	nm
Spectral Bandwidth at 50% $\Phi$ REL MAX I <sub>F</sub> = 10mA	Δλ	Yellow	35	-	nm
Capacitance	С	Yellow	20	-	pF
Forward Voltage I <sub>F</sub> = 10mA	V <sub>F</sub> <sup>[2]</sup>	Yellow	1.95	2.4	V
Reverse Current ( $V_R = 5V$ )	I <sub>R</sub>	Yellow	-	10	μA
Temperature Coefficient of $\lambda_{\text{peak}}$ $I_F$ = 10mA, -10°C $\leq T \leq 85°C$	$TC_{\lambda peak}$	Yellow	0.12	-	nm/°C
Temperature Coefficient of $\lambda_{dom}$ $I_F$ = 10mA, -10°C $\leq T \leq 85°C$	TC <sub>λdom</sub>	Yellow	0.07	-	nm/°C
Temperature Coefficient of $~V_F$ $I_F$ = 10mA, -10°C $\leq$ T $\leq$ 85°C	TCv	Yellow	-2	-	mV/°C

Notes:

1. The dominant wavelength ( $\lambda d$ ) above is the setup value of the sorting machine. (Tolerance  $\lambda d$  : ±1nm.) 2. Forward voltage: ±0.1V.

Provaria voitage: 50, 17.
 Wavelength value is traceable to CIE127-2007 standards.
 Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

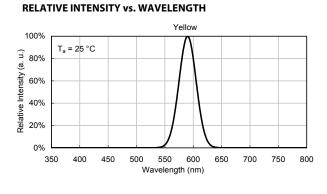
# ABSOLUTE MAXIMUM RATINGS at T<sub>A</sub>=25°C

Parameter	Symbol	Value	Unit	
Power Dissipation	P <sub>D</sub>	75	mW	
Reverse Voltage	V <sub>R</sub>	5	V	
Junction Temperature	Tj	110	°C	
Operating Temperature	T <sub>op</sub>	-40 To +85	°C	
Storage Temperature	T <sub>stg</sub>	-40 To +85	°C	
DC Forward Current	I <sub>F</sub>	30	mA	
Peak Forward Current	I <sub>FM</sub> <sup>[1]</sup>	140	mA	
Electrostatic Discharge Threshold (HBM)	-	8000	V	
Thermal Resistance (Junction / Ambient)	R <sub>th JA</sub> <sup>[2]</sup>	500	°C/W	
Thermal Resistance (Junction / Solder point)	R <sub>th JS</sub> <sup>[2]</sup>	245	°C/W	
Lead Solder Temperature <sup>[3]</sup>		260°C For 3 Seconds		
Lead Solder Temperature <sup>[4]</sup>		260°C For 5 Seconds		

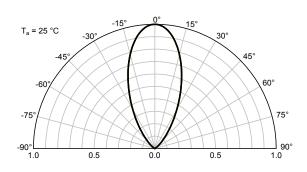
Notes: 1. 1/10 Duty Cycle, 0.1ms Pulse Width. 2. R<sub>In JA</sub>, R<sub>th JS</sub> Results from mounting on PC board FR4 (pad size ≥ 16 mm<sup>2</sup> per pad). 3. 2mm below package base. 4. 5mm below package base. 5. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

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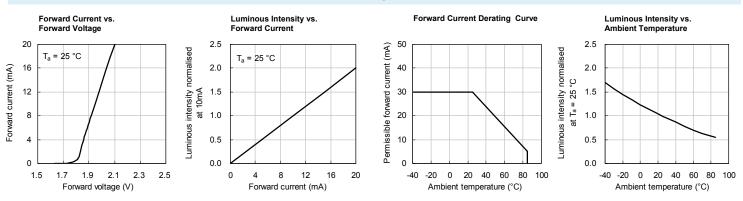
# **TECHNICAL DATA**



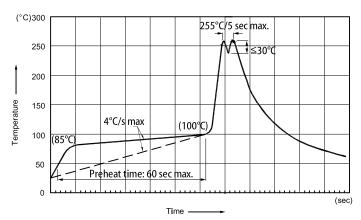
#### SPATIAL DISTRIBUTION



YELLOW



#### **RECOMMENDED WAVE SOLDERING PROFILE**



Notes:

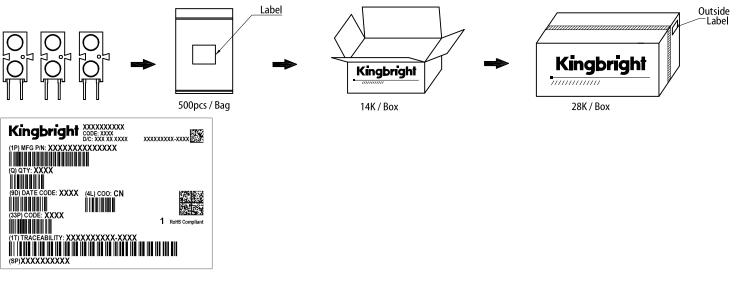
- Recommend pre-heat temperature of 105°C or less (as measured with a thermocouple attached to the LED pins) prior to immersion in the solder wave with a maximum solder bath temperature of 260°C

- temperature or 200°C 2. Peak wave soldering temperature between 245°C ~ 255°C for 3 sec (5 sec max). 3. Do not apply stress to the epoxy resin while the temperature is above 85°C. 4. Fixtures should not incur stress on the component when mounting and during soldering process.
- 5. SAC 305 solder alloy is recommended.
   6. No more than one wave soldering pass

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# PACKING & LABEL SPECIFICATIONS



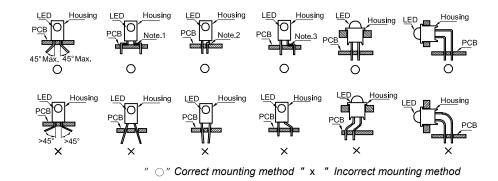
### PRECAUTIONS

#### **Storage Conditions**

- 1. Avoid continued exposure to the condensing moisture environment and keep the product away from rapid transitions in ambient temperature.
- 2. LEDs should be stored with temperature  $\leq$  30°C and relative humidity < 60%.
- 3. Product in the original sealed package is recommended to be assembled within 72 hours of opening. Product in opened package for more than a week should be baked for 30 (+10/-0) hours at 85 ~ 100°C.

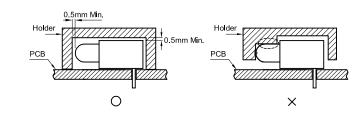
#### **LED Mounting Method**

 The lead pitch of the LED must match the pitch of the mounting holes on the PCB during component placement. Lead-forming may be required to insure the lead pitch matches the hole pitch. Refer to the figure below for proper lead forming procedures. Note 1-3: Do not route PCB trace in the contact area between the leadframe and the PCB to prevent short-circuits.



#### Lead Forming Procedures

- 1. During soldering, component covers and holders should leave clearance to avoid placing damaging stress on the LED during soldering.
- 2. The tip of the soldering iron should never touch the lens epoxy.
- 3. Through-hole LEDs are incompatible with reflow soldering.
- 4. If the LED will undergo multiple soldering passes or face other processes where the part may be subjected to intense heat, please check with Kingbright for compatibility.



#### **PRECAUTIONARY NOTES**

- 1. The information included in this document reflects representative usage scenarios and is intended for technical reference only.
- The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should refer to
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